Editorial for Journal of Packaging Technology and Research

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I recall the great initiative taken by the Indian Institute of Packaging to launch this prestigious Journal of Packaging Technology and Research (JPAC) in the year 2015 to commemorate the Golden Jubilee Celebrations of the Institute by publishing the “Synopsis” of this Journal. The first regular issue of this journal was published in January 2017. During the first year, the Institute has been able to publish three regular issues under Volume 1 with the great contribution from researchers dealing with the subject of Packaging.

Most important, the research papers were contributed by the Scientists and researchers from India and Overseas Universities. The overseas universities like Cal Poly University, USA; International Hellenic University, Greece; International Islamic University, Malaysia; Malaysian Agriculture Research and Development Institute, Malaysia; National Research Centre, Egypt; Khorramshahr University of Marine Science and Technology, Iran; Technical University of Munich, Germany have contributed original as well as review papers in the journal. Besides, the reputed Indian Universities and Institutes like Indian Institute of Packaging; Indian Institute of Technology Kharagpur; Indian Institute of Technology Delhi; National Dairy Research Institute, Karnal, Orissa University of Agriculture and Technology; Bhubaneswar, Central Institute of Agricultural Engineering, Bhopal; Jawaharlal Nehru Agricultural University, M.P; Central Institute of Fisheries Technology, Cochin; University of Mysore; Mangalore University; University College of Science; Sridevi Institute of Engineering and Technology, Tumkur; North Cap University, Haryana; National Research Centre on Meat, Hyderabad; Tamil Nadu Fisheries University, Tuticorin; Graphic Art Technology & Education, Mumbai; and Centre for Incubation, Innovation, Research

& Consultancy, Bangalore have also contributed research papers related to packaging Science & Technology.

The main aim of this journal is to publish the original high-quality research papers, reviews, research articles and IPR (Patent)-related notes on Packaging Science and Technology to highlight about innovations in different types of primary, secondary and transport packages, ancillary packaging materials, packaging machinery, assessment of functional properties of various packaging materials and packages, enhancement of shelf life study of perishable goods, etc.

It gives me immense pleasure to present this second issue of 2018 that covers different aspects like Surface and Adhesion Characteristics of Current and Next Generation Steel Packaging Materials, a review on preparation and properties of Cellulose NanoCrystal-Incorporated Natural Bio-Polymers, Influence of Modified Atmosphere Packaging (MAP) on the Shelf Life and Quality of Broccoli during Storage, Inter-layer Adhesion Performance of Steel Packaging Materials for food Cans under Retort Conditions, effect of Natural Antimicrobial (Clove and Garlic) on Shelf Life and Quality of Mushrooms (*Volvariella volvacea*) under Modified Atmosphere, Microbial, PhysicoChemical, and Sensory Analyses- Based Shelf-life Appraisal of White Fresh Cheese Packaged into PET-Waste-Based Active Packaging Film, etc.

I am sure that this journal will definitely help the researchers involved in basic as well as applied research in the field of packaging.

I would also like to invite researchers working on all aspects of Packaging research to contribute to JPAC. To submit online or to read papers published so far, please visit the journal website at <http://www.springer.com/41783>.

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